

GE06MPS06E

650V 6A SiC Schottky MPS™ Diode



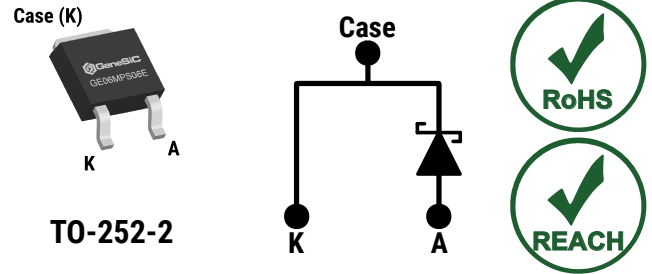
Silicon Carbide Schottky Diode

V_{RRM}	=	650 V
$I_F (T_C = 163^\circ\text{C})$	=	6 A
Q_C	=	15 nC

Features

- Gen5 Thin Chip Technology for Low V_F
- Low Conduction Losses for All Load Conditions
- Superior Figure of Merit Q_C/I_F
- Enhanced Surge Current Robustness
- Low Thermal Resistance
- Temperature Independent Fast Switching
- Positive Temperature Coefficient of V_F
- High dV/dt Ruggedness

Package



Advantages

- Optimal Price Performance
- Improved System Efficiency
- Enables Extremely Fast Switching
- Reduced Cooling Requirements
- Increased System Power Density
- Zero Reverse Recovery Current
- Easy to Parallel without Thermal Runaway
- High System Reliability

Applications

- Switched Mode Power Supply (SMPS)
- Solar Inverter
- Server and Telecom Power Supply
- Battery Charger
- Uninterruptible Power Supply (UPS)

Absolute Maximum Ratings (At $T_C = 25^\circ\text{C}$ Unless Otherwise Stated)

Parameter	Symbol	Conditions	Values	Unit	Note
Repetitive Peak Reverse Voltage	V_{RRM}		650	V	
Continuous Forward Current	I_F	$T_C = 100^\circ\text{C}, D = 1$	17	A	Fig. 4
		$T_C = 135^\circ\text{C}, D = 1$	12		
		$T_C = 163^\circ\text{C}, D = 1$	6		
Non-Repetitive Peak Forward Surge Current, Half Sine Wave	$I_{F,SM}$	$T_C = 25^\circ\text{C}, t_P = 10 \text{ ms}$	33	A	
		$T_C = 150^\circ\text{C}, t_P = 10 \text{ ms}$	27		
Repetitive Peak Forward Surge Current, Half Sine Wave	$I_{F,RM}$	$T_C = 25^\circ\text{C}, t_P = 10 \text{ ms}$	20	A	
		$T_C = 150^\circ\text{C}, t_P = 10 \text{ ms}$	14		
Non-Repetitive Peak Forward Surge Current	$I_{F,MAX}$	$T_C = 25^\circ\text{C}, t_P = 10 \mu\text{s}$	165	A	
i^2t Value	$\int i^2 dt$	$T_C = 25^\circ\text{C}, t_P = 10 \text{ ms}$	5.445	A^2s	
Non-Repetitive Avalanche Energy	E_{AS}	$L = 4.4 \text{ mH}, I_{AS} = 6 \text{ A}$	79	mJ	
Diode Ruggedness	dV/dt	$V_R = 0 \sim 520 \text{ V}$	200	V/ns	
Power Dissipation	P_{TOT}	$T_C = 25^\circ\text{C}$	133	W	Fig. 3
Operating and Storage Temperature	T_j, T_{stg}		-55 to 175	$^\circ\text{C}$	

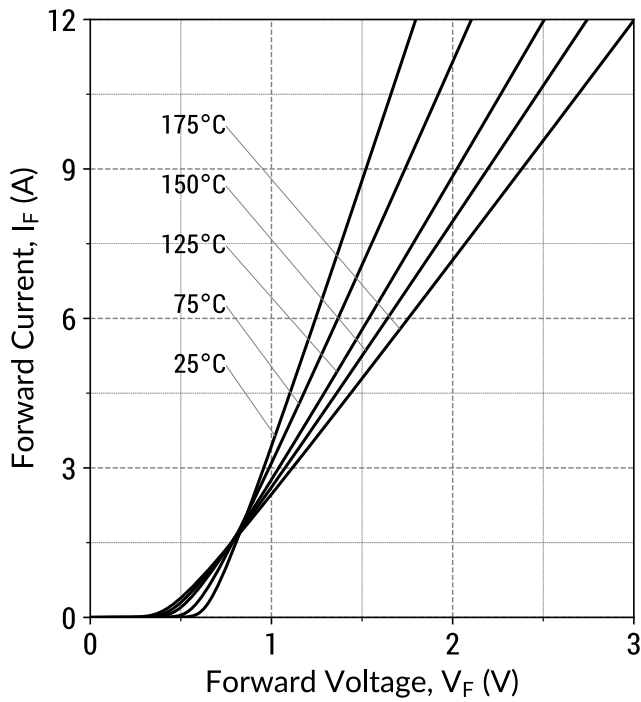
Electrical Characteristics

Parameter	Symbol	Conditions	Values			Unit	Note
			Min.	Typ.	Max.		
Diode Forward Voltage	V_F	$I_F = 6\text{ A}, T_j = 25^\circ\text{C}$		1.25	1.35	V	Fig. 1
		$I_F = 6\text{ A}, T_j = 150^\circ\text{C}$		1.64			
Reverse Current	I_R	$V_R = 650\text{ V}, T_j = 25^\circ\text{C}$		1	5	μA	Fig. 2
		$V_R = 650\text{ V}, T_j = 150^\circ\text{C}$		42			
Total Capacitive Charge	Q_C	$I_F \leq I_{F,MAX}$	$V_R = 200\text{ V}$	10		nC	Fig. 7
			$V_R = 400\text{ V}$	15			
Switching Time	t_s	$dI_F/dt = 200\text{ A}/\mu\text{s}$	$V_R = 200\text{ V}$	< 10		ns	
			$V_R = 400\text{ V}$				
Total Capacitance	C	$V_R = 1\text{ V}, f = 1\text{ MHz}$		279		pF	Fig. 6
		$V_R = 400\text{ V}, f = 1\text{ MHz}$		20			

Thermal/Package Characteristics

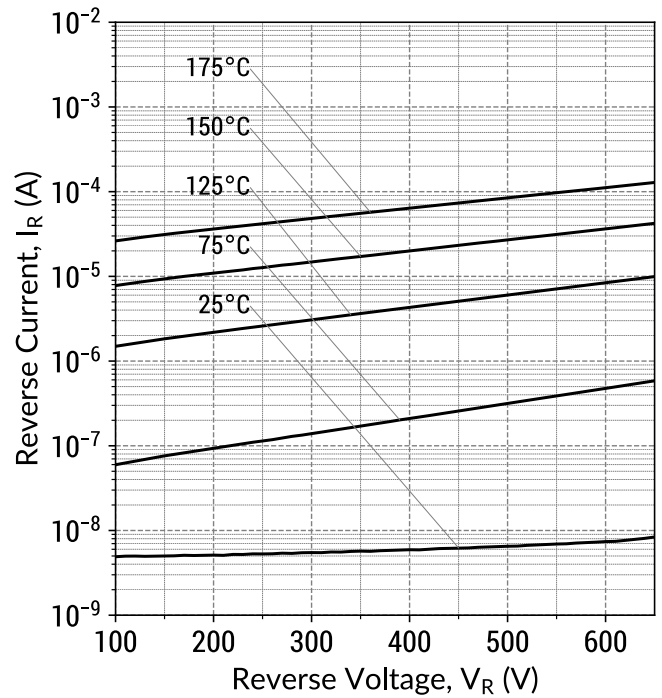
Parameter	Symbol	Conditions	Values			Unit	Note
			Min.	Typ.	Max.		
Thermal Resistance, Junction - Case	R_{thJC}			1.13		$^\circ\text{C}/\text{W}$	Fig. 9
Weight	W_T			0.3		g	

Figure 1: Typical Forward Characteristics



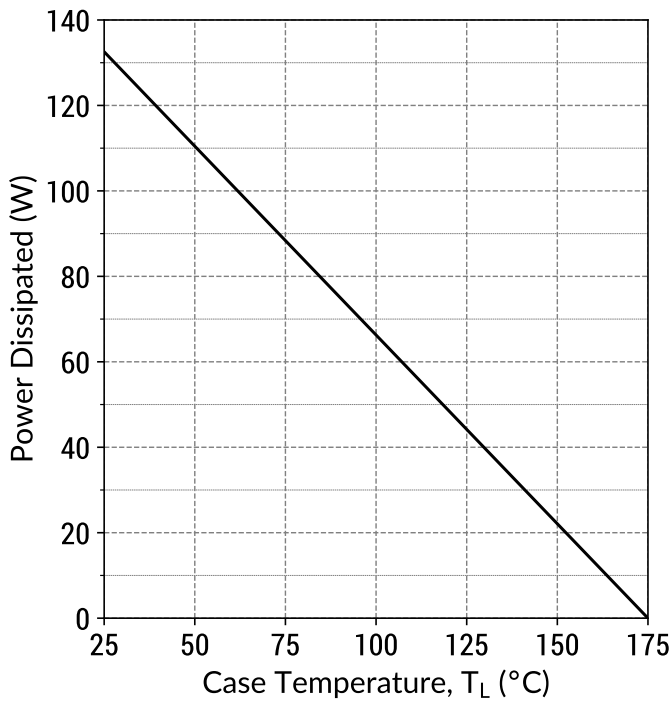
$I_F = f(V_F, T_j); t_P = 250 \mu s$

Figure 2: Typical Reverse Characteristics



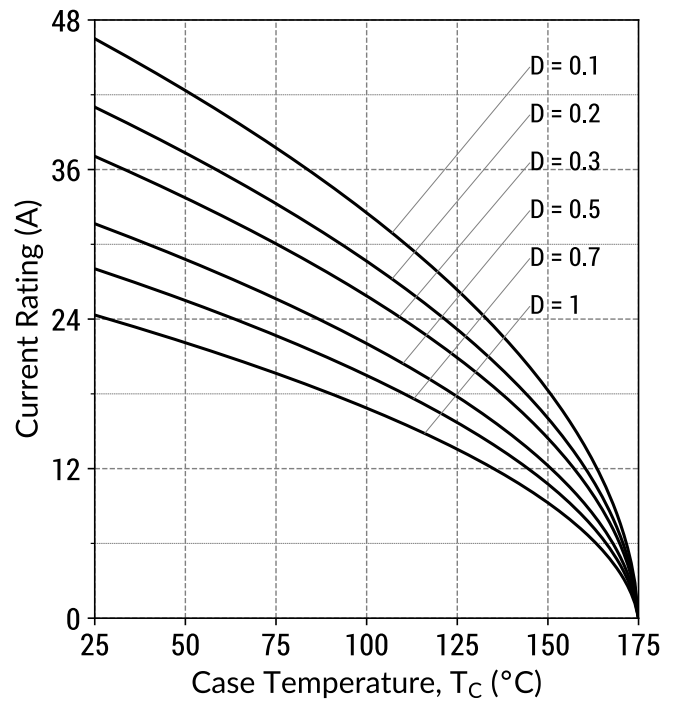
$I_R = f(V_R, T_j)$

Figure 3: Power Derating Curves



$P_{TOT} = f(T_C); T_j = 175^\circ C$

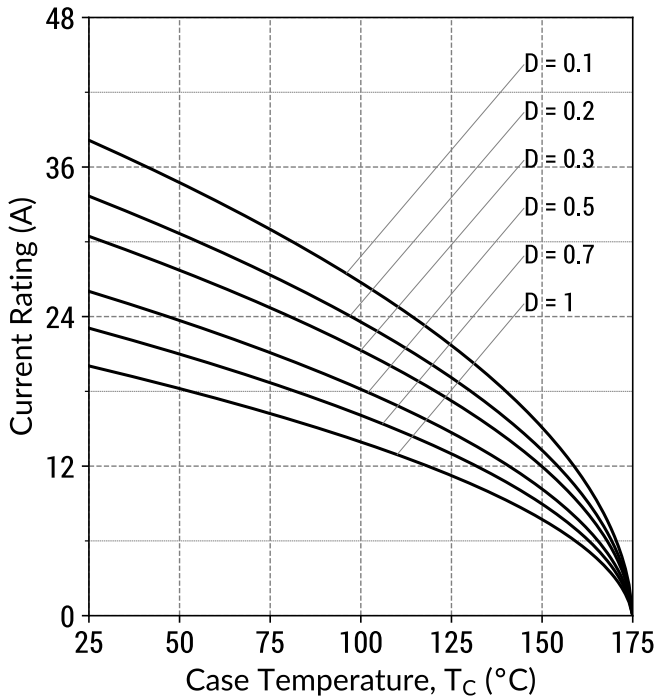
Figure 4: Current Derating Curves (Typical V_F)



$I_F = f(T_C); D = t_P/T; T_j \leq 175^\circ C; f_{sw} > 10kHz$

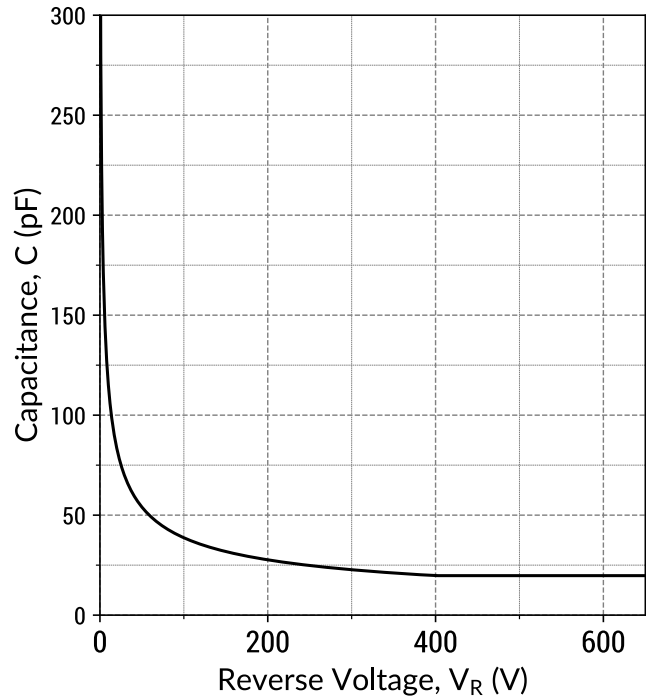


Figure 5: Current Derating Curves (Maximum V_F)



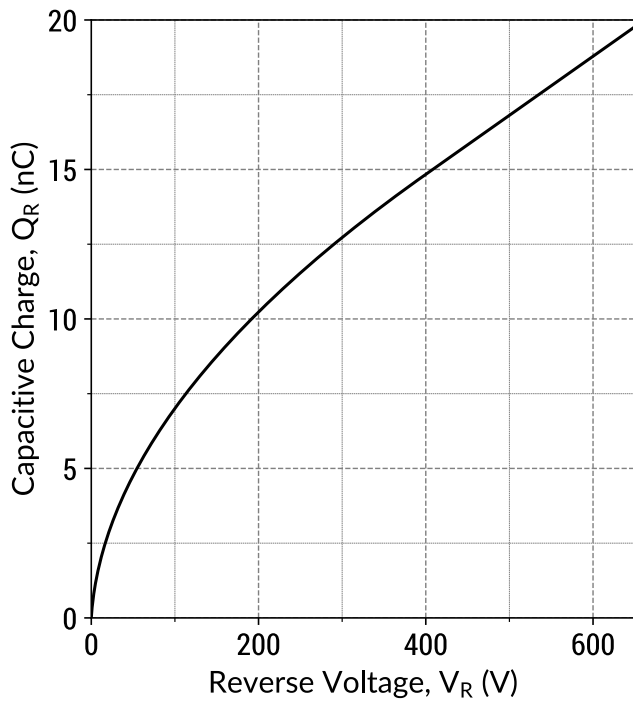
$I_F = f(T_C)$; $D = t_P/T$; $T_J \leq 175^\circ\text{C}$; $f_{sw} > 10\text{kHz}$

Figure 6: Typical Junction Capacitance vs Reverse Voltage Characteristics



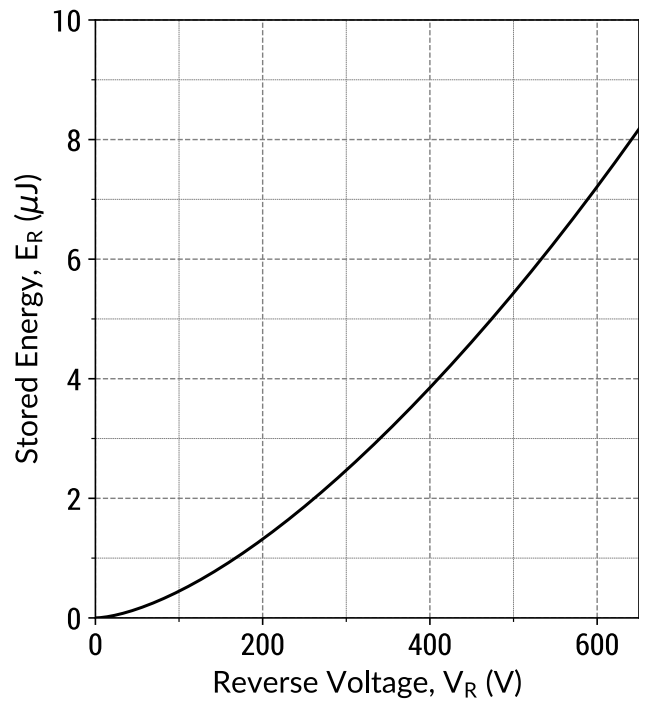
$C = f(V_R)$; $f = 1\text{MHz}$

Figure 7: Typical Capacitive Charge vs Reverse Voltage Characteristics



$Q_C = f(V_R)$; $f = 1\text{MHz}$

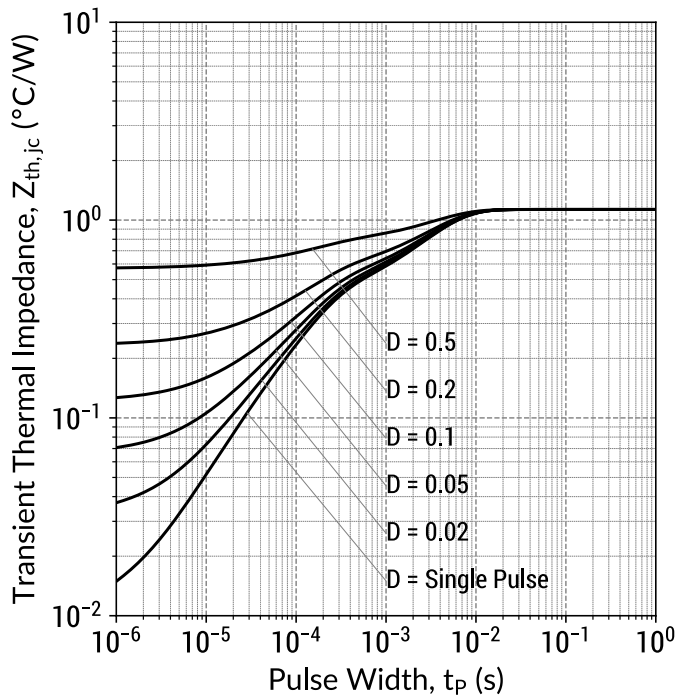
Figure 8: Typical Capacitive Energy vs Reverse Voltage Characteristics



$E_C = f(V_R)$; $f = 1\text{MHz}$



Figure 9: Transient Thermal Impedance



$$Z_{th,jc} = f(t_p, D); D = t_p/T$$

Figure 10: Forward Curve Model



$$I_F = f(V_F, T_j)$$

Forward Curve Model Equation:

$$I_F = (V_F - V_{BI})/R_{DIFF} \text{ (A)}$$

Built-In Voltage (V_{BI}):

$$V_{BI}(T_j) = m \times T_j + n \text{ (V)}$$

$$m = -0.00124 \text{ (V/°C)}$$

$$n = 0.72 \text{ (V)}$$

Differential Resistance (R_{DIFF}):

$$R_{DIFF}(T_j) = a \times T_j^2 + b \times T_j + c \text{ (}\Omega\text{)}$$

$$a = 1.6e-06 \text{ (}\Omega\text{/°C}^2\text{)}$$

$$b = 0.000454 \text{ (}\Omega\text{/°C)}$$

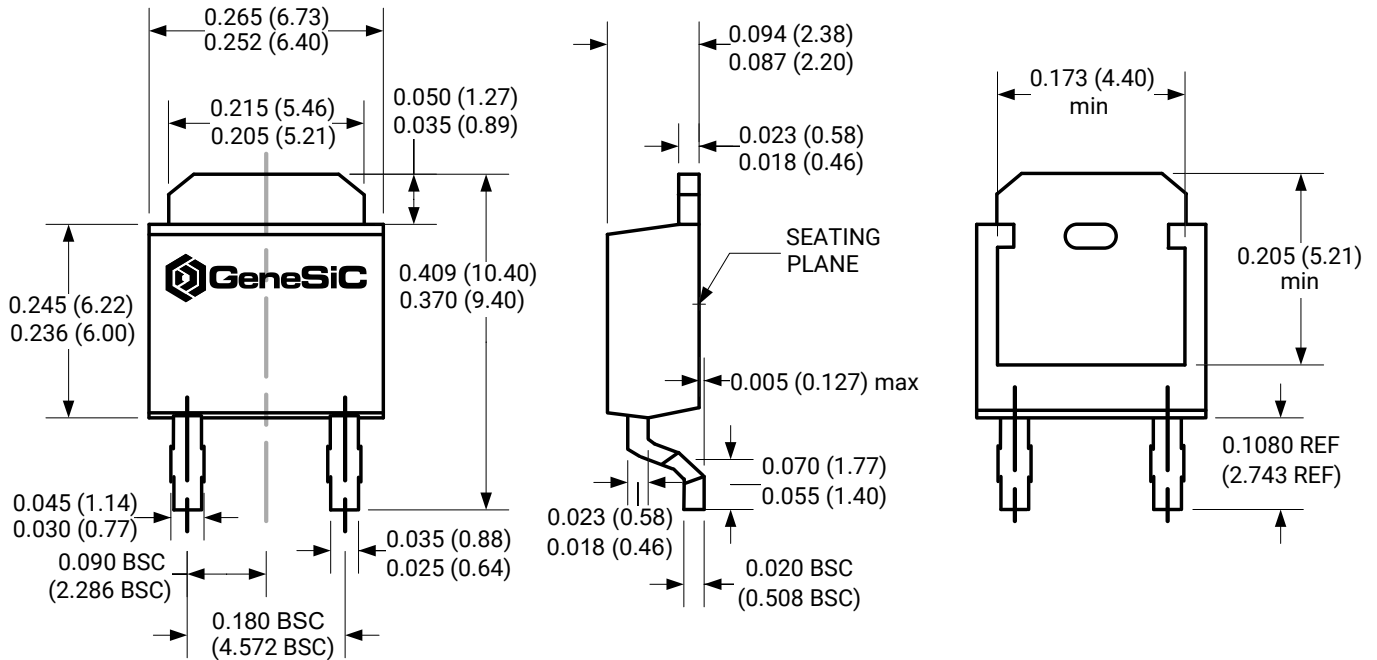
$$c = 0.0802 \text{ (}\Omega\text{)}$$

Forward Power Loss Equation:

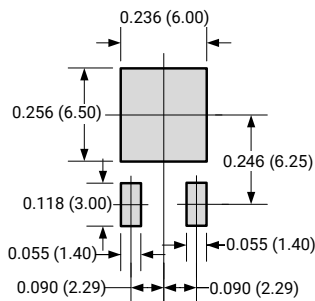
$$P_{LOSS} = V_{BI}(T_j) \times I_{AVG} + R_{DIFF}(T_j) \times I_{RMS}^2$$

Package Dimensions

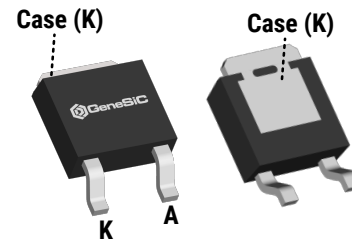
TO-252-2 Package Outline



Recommended Solder Pad Layout



Package View



NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS.

Compliance

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS 2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863. RoHS Declarations for this product can be obtained from your GeneSiC representative.

REACH Compliance

REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a GeneSiC representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

Disclaimer

GeneSiC Semiconductor, Inc. reserves right to make changes to the product specifications and data in this document without notice. GeneSiC disclaims all and any warranty and liability arising out of use or application of any product. No license, express or implied to any intellectual property rights is granted by this document.

Unless otherwise expressly indicated, GeneSiC products are not designed, tested or authorized for use in life-saving, medical, aircraft navigation, communication, air traffic control and weapons systems, nor in applications where their failure may result in death, personal injury and/or property damage.

Related Links

- SPICE Models: https://www.genesicsemi.com/sic-schottky-mps/GE06MPS06E/GE06MPS06E_SPICE.zip
- PLECS Models: https://www.genesicsemi.com/sic-schottky-mps/GE06MPS06E/GE06MPS06E_PLECS.zip
- CAD Models: https://www.genesicsemi.com/sic-schottky-mps/GE06MPS06E/GE06MPS06E_3D.zip
- Evaluation Boards: <https://www.genesicsemi.com/technical-support>
- Reliability: <https://www.genesicsemi.com/reliability>
- Compliance: <https://www.genesicsemi.com/compliance>
- Quality Manual: <https://www.genesicsemi.com/quality>

Revision History

Date	Revision	Comments	Supersedes
Jul. 27, 2020	Rev 1	Initial Release	



www.genesicsemi.com/sic-schottky-mps/

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [Schottky Diodes & Rectifiers](#) category:

Click to view products by [GeneSiC Semiconductor](#) manufacturer:

Other Similar products are found below :

[MA4E2039](#) [D1FH3-5063](#) [MBR0530L-TP](#) [MBR10100CT-BP](#) [MBR1545CT](#) [MMBD301M3T5G](#) [RB160M-50TR](#) [RB551V-30](#)
[BAS16E6433HTMA1](#) [BAT 54-02LRH E6327](#) [NSR05F40QNXT5G](#) [NTE555](#) [JANS1N6640](#) [SB07-03C-TB-H](#) [SB1003M3-TL-W](#) [SK310-T](#)
[SK32A-LTP](#) [SK34B-TP](#) [SS3003CH-TL-E](#) [GA01SHT18](#) [CRS10I30A\(TE85L,QM](#) [MA4E2501L-1290](#) [MBRB30H30CT-1G](#) [SB007-03C-TB-](#)
[E](#) [SK32A-TP](#) [SK33B-TP](#) [SK38B-TP](#) [NRVBM120LT1G](#) [NTE505](#) [NTSB30U100CT-1G](#) [SS15E-TP](#) [VS-6CWQ10FNHM3](#) [ACDBA1100LR-](#)
[HF](#) [ACDBA1200-HF](#) [ACDBA140-HF](#) [ACDBA2100-HF](#) [ACDBA3100-HF](#) [CDBQC0530L-HF](#) [CDBQC0240LR-HF](#) [ACDBA260LR-HF](#)
[ACDBA1100-HF](#) [SK310B-TP](#) [MA4E2502L-1246](#) [MA4E2502H-1246](#) [NRVBM120ET1G](#) [NSR01L30MXT5G](#) [NTE573](#) [NTE6081](#) [SB560](#)
[PMAD1108-LF](#)